

June 2014

### **FQA140N10**

### N-Channel QFET® MOSFET 100 V, 140 A, 10 $m\Omega$

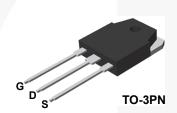
### **Description**

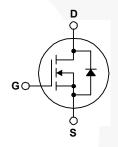
### This N-Channel enhancement mode power MOSFET is • 140 A, 100 V, $R_{DS(on)}$ = 10 m $\Omega$ (Max.) @ $V_{GS}$ = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 220 nC) resistance, and to provide superior switching performance and Low Crss (Typ. 470 pF) high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor • 100% Avalanche Tested control, and variable switching power applications.

### **Features**

- $I_D = 70 A$

- 175°C Maximum Junction Temperature Rating





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQA140N10	Unit	
$V_{DSS}$	Drain-Source Voltage	100	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)	140	Α	
	- Continuous (T <sub>C</sub> = 100°C)	99	А	
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	560	A	
V <sub>GSS</sub>	Gate-Source Voltage	± 25	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	1500	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)	140	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	37.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)	6.5	V/ns	
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C)	375	W	
	- Derate above 25°C	2.5	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +175	°C	
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds.	300	°C	

### **Thermal Characteristics**

Symbol	Parameter	FQA140N10	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.4	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W	

### **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA140N10	FQA140N10	TO-3PN	Tube	N/A	N/A	30 units

### **Electrical Characteristics**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Uni
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	100			V
ΔBV <sub>DSS</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C		0.08		V/°(
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μΑ
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 64 V, T <sub>C</sub> = 150°C		-	10	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 25 V, V <sub>DS</sub> = 0 V		-	100	nΑ
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -25 V, V <sub>DS</sub> = 0 V			-100	nΑ
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 70 A		0.008	0.01	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 70 A		80		S
	ic Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		6100	7900	pF
C <sub>oss</sub>	Output Capacitance			2000	2600	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			420	550	pF
Switchi	ing Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			75	160	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 40 \text{ V}, I_{D} = 140 \text{ A},$ $R_{G} = 25 \Omega$		940	1890	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	11G - 23 22		350	710	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		360	730	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 64 V, I <sub>D</sub> = 140 A,		220	285	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V		39		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4)		114		nC
	Source Diode Characteristics at				110	Α.
l <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current (Note 5)				140	Α

# $Q_{rr}$

t<sub>rr</sub>

 $I_{SM}$ 

 $V_{SD}$ 

Drain-Source Diode Forward Voltage

Reverse Recovery Time

Reverse Recovery Charge

- Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 0.115 mH, I<sub>AS</sub> = 140 A, V<sub>DD</sub> = 25 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C. 3. I<sub>SD</sub> = 140 A, di/dt  $\leq$  300 A/ $\mu$ s, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub> starting T<sub>J</sub> = 25°C. 4. Essentially independent of operating temperature. 5. Continuous drain current calculated by maximum junction temperature : limited by package.

Maximum Pulsed Drain-Source Diode Forward Current

560

1.5

140

730

--

Α

٧

ns

nC

 $V_{GS} = 0 \text{ V}, I_{S} = 140 \text{ A}$ 

 $V_{GS} = 0 \text{ V, } I_{S} = 140 \text{ A,}$ 

 $dI_F / dt = 100 A/\mu s$ 

### **Typical Characteristics**

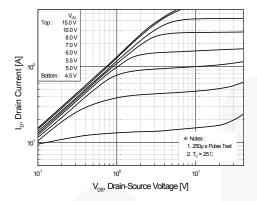


Figure 1. On-Region Characteristics

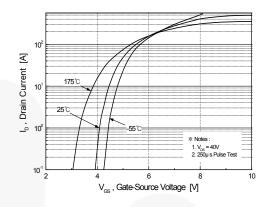


Figure 2. Transfer Characteristics

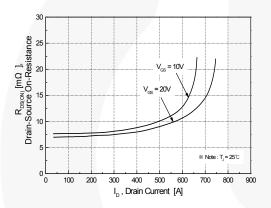


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

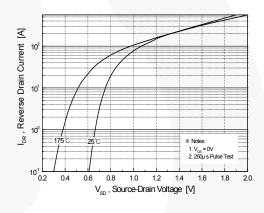


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

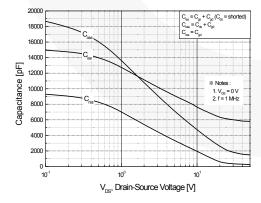


Figure 5. Capacitance Characteristics

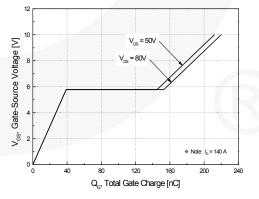


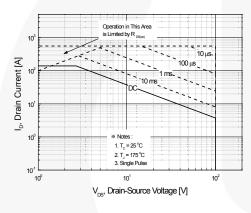
Figure 6. Gate Charge Characteristics

# 12 (Nomalized) 1.1 (Nomalized

Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



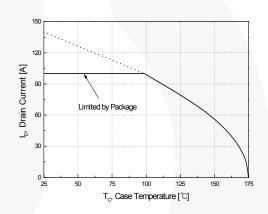


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

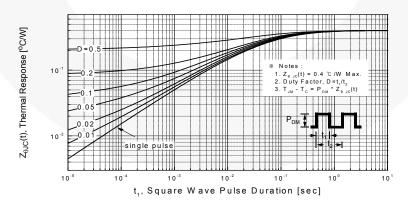


Figure 11. Transient Thermal Response Curve

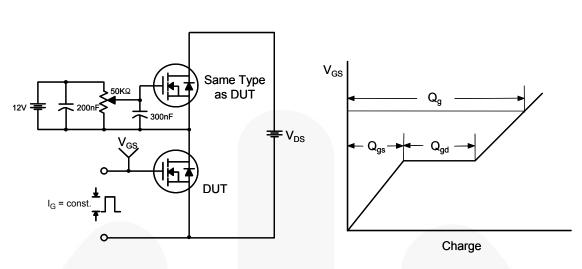


Figure 12. Gate Charge Test Circuit & Waveform

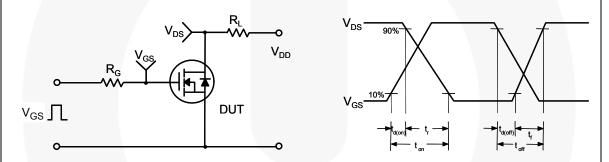


Figure 13. Resistive Switching Test Circuit & Waveforms

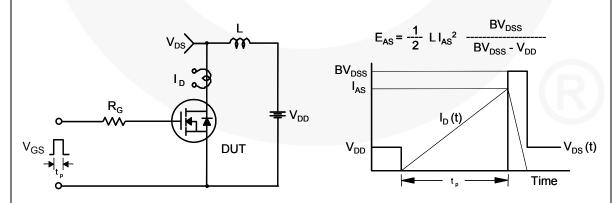
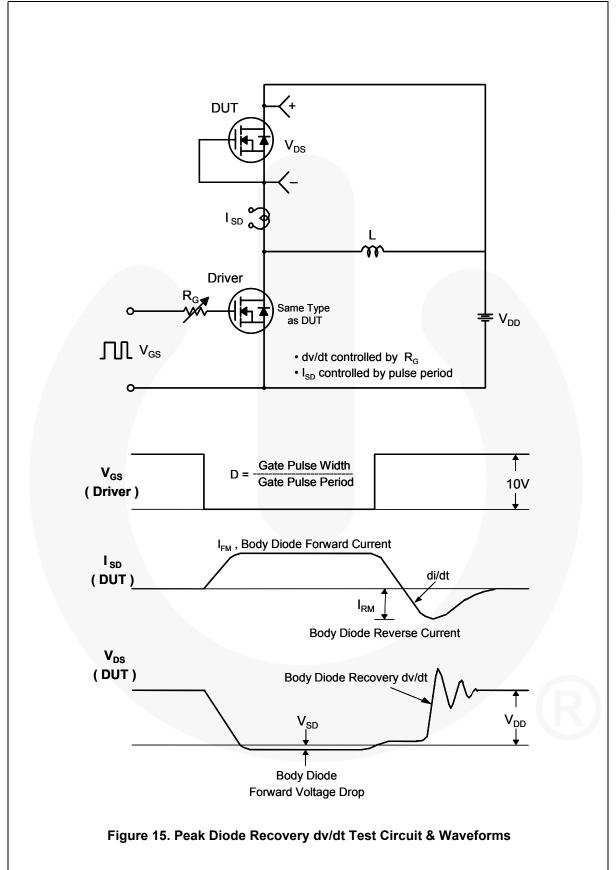
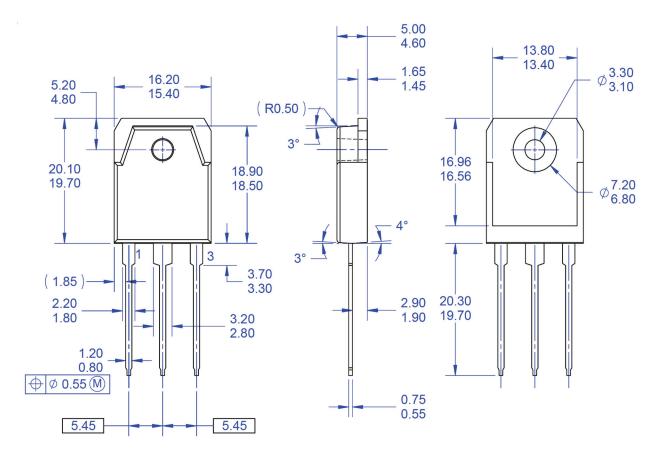
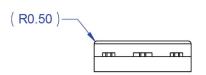


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



### **Mechanical Dimensions**





### NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO EIAJ SC-65 PACKAGING STANDARD.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
  C) DIMENSION AND TOLERANCING PER
- ASME14.5-2009.
  D) DIMENSIONS ARE EXCLUSSIVE OF BURRS,
- MOLD FLASH, AND TIE BAR EXTRUSSIONS.

  E) DRAWING FILE NAME: TO3PN03AREV1.
- F) FAIRCHILD SEMICONDUCTOR.

### Figure 16. TO3PN, 3-Lead, Plastic, EIAJ SC-65

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

7

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN\_TT3PN-003





#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

intended to be an exhaustive list of AccuPower™
AX-CAP®\*
BitSiC™
Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™
CUrrent Transfer Logic™
DELIXPEED®

DEUXPEED®
DEUXPEED®
Dual Cool™
EcoSPARK®
EfficentMax™
ESBC™

Fairchild®

Fairchild Semiconductor<sup>®</sup>
FACT Quiet Series<sup>™</sup>
FACT<sup>®</sup>
FAST<sup>®</sup>

FastvCore™ FETBench™ FPS™ F-PFS™ FRFET<sup>®</sup>

Global Power Resource<sup>SM</sup> GreenBridge™

Green FPS™ Green FPS™ e-Series™

Gmax™ GTO™ IntelliMAX™ ISOPLANAR™

Marking Small Speakers Sound Louder

and Better™ MegaBuck™ MICROCOUPLER™ MicroPET™

MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver® OptoHiT™ OPTOLOGIC® OPTOPLANAR® ® PowerTrench® PowerXS™

Programmable Active Droop™

QFET®
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™

SmartMax™ SMART START™

Solutions for Your Success™

SPM<sup>®</sup>
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™

SYSTEM ®\*

TinyBoost®
TinyBuck®
TinyCalc™
TinyLogic®
TinyPOPTO™
TinyPOwer™
TinyPower™
TinyPWire™
TranSiC™
TriFault Detect™
TRUECURRENT®\*\*
uSerDes™

SerDes

UHC<sup>®</sup>
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™
仙童™

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are
  intended for surgical implant into the body or (b) support or sustain life,
  and (c) whose failure to perform when properly used in accordance with
  instructions for use provided in the labeling, can be reasonably
  expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers by either from Fairchild directly or from Authorized Fairchild's pullity standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

## PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. I68

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FQA140N10